

5.0 GHz to 18.0 GHz **Medium Power Amplifier**

ADH451S

1.0 Scope

This specification documents the detail requirements for an internally defined equivalent flow per MIL-PRF-38535 Level V expect as modified herein.

The manufacturing flow described in the RF & MICROWAVE STANDARD SPACE LEVEL PRODUCTS PROGRAM is to be considered a part of this specification.

This data specifically details the space grade version of this product. A more detailed operational description and a complete data sheet for commercial product grades can be found at http://www.analog.com/HMC451

2.0 Part Number:

The complete part number(s) of this specification follows:

Specific Part Number	Description
ADH451-701LH5	5.0 GHz to 18.0 GHz Medium Power Amplifier

3.0 Case Outline

The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline Letter	Descriptive Designator	<u>Terminals</u>	<u>Lead Finish</u>	Package style
Х	E-12-5	12 Lead	Gold	Ceramic Hermetic SMT (LH5)

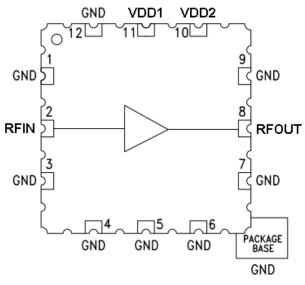


Figure 1 – Functional Block Diagram

ASD0016593

Rev. B Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective companies.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 www.analog.com Fax: 781.326.8703 © 2019 Analog Devices, Inc. All rights reserved.

ADH451S

	Package: X					
Pin Terminal Number Symbol Pin Type			Pin Description	Interface Schematic		
1	GND	Power	Must be connected to RF/DC ground.			
2	RFIN	Input	RF Input <u>1</u> /			
3	GND	Power	Must be connected to RF/DC ground.			
4	GND	Power	Must be connected to RF/DC ground.	0.0110		
5	GND	Power	Must be connected to RF/DC ground	O GND		
6	GND	Power	Must be connected to RF/DC ground	=		
7	GND	Power	Must be connected to RF/DC ground			
8	RFOUT	Output	RF Output <u>1</u> /			
9	GND	Power	Must be connected to RF/DC ground.			
10	VDD2	Power	Power Supply Voltage for the amplifier. <u>2</u> /	Vdd2		
11	VDD1	Power	Power Supply Voltage for the amplifier. <u>2</u> /			
12	GND	Power	Must be connected to RF/DC ground.	GND =		
Package Bottom	GND	Power	RF/DC ground <u>3/ 4</u> /	GND		
Package Lid	GND	Power		<u> </u>		

Figure 1 – <u>Terminal connections</u>

- $\begin{array}{l} \underline{1} / \mbox{ This pin is AC coupled and matched to 50 Ohms.} \\ \underline{2} / \mbox{ External bypass capacitors of 100 pF, 1000 pF and 2.2 $$$ µF are required.} \\ \underline{3} / \mbox{ Package bottom must be connected to RF/DC ground.} \\ \underline{4} / \mbox{ Package lid is internally connected to RF/DC ground.} \end{array}$

ASD0016593 Rev. B | Page 2 of 7

4.0 Specifications

4	.1. <u>Absolute Maximum Ratings 1</u> /	
	Drain Bias Voltage (Vdd1 = Vdd2)	. 5.5 V <u>2</u> /
	RF Input Power (RFIN) (Vdd1 = Vdd2 = +5V)	. +10 dBm
	Channel Temperature	. +175°C
	Continuous Pdiss (T = +85°C) (Derate 9.29mW/°C above +85°C) .	. 0.836W
	Thermal resistance (Channel to package bottom)	. 107.64 °C/W
	Storage temperature range	65°C to +150°C
	ESD Sensitivity (HBM)	. Class 1A, passed 250V
4	.2. <u>Recommended Operating Conditions</u>	
	Supply voltage (Vdd1 = Vdd2)	. +4.5V to +5.5V
	Ambient operating temperature range (T _A)	40°C to +85°C
4	.3. Nominal Operating Performance Characteristics 3/	
	Input Return Loss (IRL) (5 GHz – 13 GHz)	. 11 dB
	Input Return Loss (IRL) (13 GHz – 18 GHz)	. 5 dB
	Output Return Loss (ORL) (5 GHz – 13 GHz)	. 11 dB
	Output Return Loss (ORL) (13 GHz – 18 GHz)	. 5 dB
	Noise Figure (NF) (5 GHz – 13 GHz)	. 8 dB
	Noise Figure (NF) (13 GHz – 18 GHz)	. 6.5 dB
	Saturated Output Power (Psat) (5 GHz – 13 GHz)	. 22 dBm <u>4</u> /
	Saturated Output Power (Psat) (13 GHz – 18 GHz)	. 20 dBm <u>4</u> /
	Output Third Order Intercept (OIP3) (5 GHz – 13 GHz)	. 30 dBm <u>5</u> /
	Output Third Order Intercept (OIP3) (13 GHz – 18 GHz)	. 28 dBm <u>5</u> /

1/ Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions outside of those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

2/ All voltages are relative to their respective grounds. 3/ All typical specifications are at $T_A = 25^{\circ}$ C and Vdd1 = Vdd2 = +5 V, unless otherwise noted. 4/ Psat specified as OP5dB 5/ RFOUT = 0 dBm per tone, 1MHz spacing.

Parameter	Cumhal	Conditions <u>1</u> /	Group A	Limits		Units
See notes at end of table	Symbol	Unless otherwise specified	Subgroups	Min	Max	Units
Frequency = 5.0GHz Cont	inuous W	ave (CW) input				
Gain	S21	RF In =-10dBm	4	16		dB
Gain	521		5, 6	14		dB
Gain Variation Over Temperature	S21/ºC	RF In =-10dBm	4, 5, 6		0.035	dB/ºC
Output Power for 1dB	OP1dB		7	16.5		dBm
Compression	OFTUD		8A, 8B	16		ubiii
Frequency = 11.5GHz Cor	ntinuous \	Wave (CW) input				
Gain	S21	RF In =-10dBm	4	15		dB
Gain	521		5, 6	13		dB
Gain Variation Over Temperature	S21/ºC	RF In =-10dBm	4, 5, 6		0.035	dB/ºC
Output Power for 1dB			7	16		dBm
Compression	OP1dB		8A, 8B	15		dBm
Frequency = 18.0GHz Cor	ntinuous \	Wave (CW) input				
Gain	S21	BE ln = -10 dBm	4	14		dB
Gain	521	RF In = 10 dBm	5, 6	12		dB
Gain Variation Over Temperature	S21/ºC	RF In =-10dBm	4, 5, 6		0.035	dB/ºC
Output Power for 1dB	OP1dB		7	16.5		dBm
Compression	OPTOB		8A, 8B	16		dBm
Power Supplies						
Quiescent supply current	Idd	No signal at RFIN	1, 2, 3		150	mA

TABLE I – ELECTRICAL PERFORMANCE CHARACTERISTICS

Table I Note:

<u>1</u>/ T_A nom = +25°C, T_A max = +85°C, T_A min = -40°C and Vdd1 = Vdd2 =+ 5V nom.

TABLE IIA – ELECTRICAL TEST REQUIREMENTS

Test Requirements	Subgroups (in accordance with MIL-PRF-38535, Table III)
Interim Electrical Parameters	1, 4
Final Electrical Parameters	1, 4, 7 <u>1/ 2</u> /
Group A Test Requirements	1, 2, 3, 4, 5, 6, 7, 8A, 8B
Group C end-point electrical parameters	1, 4, 7 <u>2</u> /
Group D end-point electrical parameters	1, 4, 7

Table IIA Notes:

 $\underline{1}/\operatorname{PDA}$ applies to Table I subgroup 1 only and Table IIB delta parameters. $\underline{2}/\operatorname{See}$ Table IIB for delta parameters

Parameter	Test Conditions	Symbol	Delta	Units
Gain	Der Tehle I	S21	± 1.0	dB
Quiescent supply current	Per Table I	Idd	±10	%

TABLE IIB – BURN-IN/LIFE TEST DELTA LIMITS 1/2/

Table IIB Notes:

1/240 hour burn in and 1000 hour life test (Group C) end-point electrical parameters. 2/ Deltas are performed at room temperature T_A = +25°C only.

5.0 Burn-In Life Test, and Radiation

- 5.1. Burn-In Test Circuit, Life Test Circuit
 - 5.1.1.The test conditions and circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 test condition D of MIL-STD-883.
 - 5.1.2.HTRB is not applicable for this drawing.

6.0 MIL-PRF-38535 QMLV Exceptions

6.1. Wafer Fabrication

Foundry information is available on request.

6.2. <u>Group D</u>

Group D-5 Salt Atmosphere is not performed.

ADH451S

7.0 Application Notes

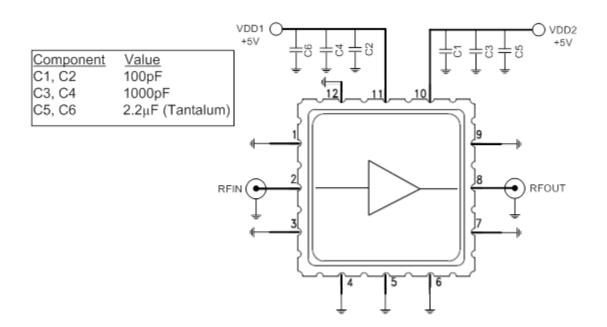


Figure 2 – <u>Recommended configuration for the ADH451-701LH5</u>

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane. A sufficient number of via holes should be used to connect the top and bottom ground planes. The circuit board should be mounted to an appropriate heat sink.

8.0 Package Outline Dimensions

The LH5 package and outline dimensions can be found at http://www.analog.com or upon request.

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
ADH451-701LH5	-40°C to +85°C	12 Lead Ceramic Hermetic SMT	LH5 (E-12-5)

	Revision History				
Rev	Rev Description of Change				
А	Initiate.	12/21/18			
В	B Update Section 3.0, 4.3, 6.0, 7.0, & 8.0				

© 2019 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective companies. Printed in the U.S.A. 05/19



www.analog.com

ASD0016593 Rev. B | Page 7 of 7